# Low-profile type with thickness of 1mm





Ite	ms	Specifications		
Rating (max.)/(mi (Resistive load)	n.)	1mA 5V DC / 50 \( \mu A 3V DC		
Contact resistanc (Initial / After oper	-	2Ω max. / 5Ω max.		
Operating force		0.35N max.		
Operating life	Without load	50,000cycles		
Operating life	With load	50,000cycles (1mA 5V DC)		

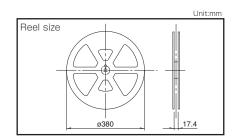
# Product Line

Poles	Positions	Terminal type	Lever length	Operating direction	Location lug	Location lug		lug Minimumorder unit (pcs)  Japan Export		Product No.	Drawing No.		
				direction		Japan	EXPOIL						
				Right	With			SPVN110101	1				
			Standard		Without			SPVN120101					
	1 1 For PC board (Reflow)	Standard	l oft	With			SPVN210101	2					
1				Left	Without	5,000	20,000	SPVN220101					
ı			Long	Right	Right	With	3,000 20,00	20,000	SPVN310100	3			
					Without			SPVN320100					
				Left	With			SPVN410100	4				
					Left	Left	Left	Left	Left	Without			SPVN420100

# Packing Specifications

# Taping

Nun	nber of packages (p	Tape width	Export package measurements (mm)	
1 reel	eel 1 case /Japan 1 case /export packing			
5,000	10,000	20,000	16	417×409×139



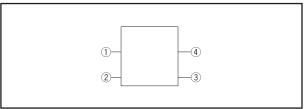
Dim	nensions		Unit:mm
No.	Photo	Style	PC board mounting hole and land dimensions (Viewed from direction A)
1	Right operation type with boss	ON starting position (horizontal direction), operating force standard measurement posi	1.6 2.00.75 note 1.8 90 2.00.75 note 1.8 0.0

Dimensions PC board mounting hole and land dimensions (Viewed from direction A ) No. Photo Style Left operation type with boss ON starting position (horizontal direction) 2 ON starting position (Vertical direction) Right operation type with boss 2-00.75 hole 3 Left operation type with boss 4

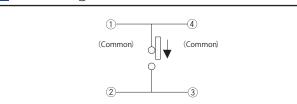
### Note

Dimensions drawing is for type with location lugs.

# ■ Terminal Layout (Viewed from Direction A)



# Circuit Diagram



# List of Varieties

	2			General-pu	rpose Type		
	Series	SPVS	SPVN	SPVT	SPVM	SPVR	SPVE
I	Photo						
Oper	ation type		1	Two-way		I	One-way
	W	3.5	3.8	5.6	2.8	3.6	3.4
Dimensio (mm)	ns D	3.3	3.6	4.7	3.5	4.2	3
	Н		1	1.9	1.5	1.2	2.3
Operating to	emperature range			-40°C to +85°C	-40°C to +85°C		
Autor	notive use	•	•	•	•	•	_
Life cycl	e (availability)	*3	★3	**3	*3	**3	<b>*</b> 3
Poles	/ Positions			1,	/1		
Rating (max.) (Resistive load)		1mA !	5V DC	50mA 20V DC	1mA 5V DC		0.1A 30V DC
Rating (min.) (Resistive load)		50 <i>μ</i> Α	3V DC	100μA 3V DC	50μA 3V DC	100μA 3V DC	50μA 3V DC
	Operating life without load	50,000cycles 5Ω max.		100,000cycles 1Ω max.	$50,000$ cycles $5\Omega$ max.		50,000cycles 1Ω max.
Durability	Operating life with load Rating (max.) (Resistive load)	50,000cycles 5Ω max.		100,000cycles 1Ω max.	50,000cycles 5Ω max.		50,000cycles 1Ω max.
	Initial contact resistance	20	max.	500mΩ max.	2Ω max.	3Ω max.	500mΩ max.
Electrical performance	Insulation resistance	100MΩ min. 100V DC					
	Voltage proof						
Mechanical	Terminal strength		0.5N for 1minute		1N for 1minute	0.5N for	- Iminute
performance	Actuator strength	5N		10N	5N	2N	5N
	Cold			-40℃ 96h			-20°C 96h
Environmental performance	Dry heat	85°C 96h					
	Damp heat	40℃, 90 to 95%RH 96h					
Opera	ation force	0.351	N max.	0.4N	max.	0.35N max.	0.3N max.
	Page	16	19	21	24	26	27

# Note

Slide

Push

Rotary

Packag

Generalpurpose Type

> /ater-proof Type

Indicates applicability to all products in the series.

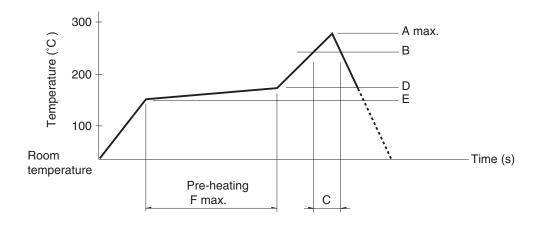
Push

# **Example of Reflow Soldering Condition**

- 1. Heating method: Double heating method with infrared heater.
  2. Temperature measurement: Thermocouple \$\phi 0.1\$ to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
  A heat resisting tape should be used for fixed measurement.

Detector Switches Soldering Conditions

3. Temperature profile



Series (Reflow type)	A (℃) 3s max.	В (℃)	C (s)	D (°C)	E (℃)	F(s)
SPPB	250		40			
SPPW8	250		35		150	120
SPVE						
SPVL						
SPVM			40			
SPVN	260	230		180		
SPVR						
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC	250					

- 1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

### ■ Reference for Hand Soldering

Series	Soldering temperature	Soldering time	
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SPPW8,SSCQ, SSCM, SPVL, SSCT, SPVQC	350±5℃	3s max.	
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10℃	3+1/0s	
SPPB (Reflow)	300±5℃	5s max.	
SSCF, SPPB (For Lead, Dip)	350±10℃	3+1/0s	

# ■ Reference for Dip Soldering (For PC board terminal types)

	Ite	ms	Dip soldering		
Series	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion	
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10℃	60s max.	260±5℃	5±1s	
SPPW8, SPPB	100 ℃ max.	60s max.	255±5℃	5±1s	
SSCF	_		260±5℃	5±1s	



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